

HY4306W-VB Datasheet N-Channel 60 V (D-S) MOSFET

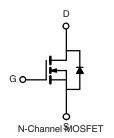
PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0016			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0020			
I _D (A)	270			
Configuration	Single			

FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- \bullet 100 % R_g and UIS tested







ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage	V_{GS}	± 20	V			
Continuous Drain Current	T _C = 25 °C	1-	270			
	T _C = 125 °C	I _D	120 ^a			
Continuous Source Current (Diode Conduction)	I _S	120 ^a	Α			
Pulsed Drain Current ^b	I _{DM}	600				
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	75			
Single Pulse Avalanche Energy	L = 0.1 IIIII	E _{AS}	281	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	375	W		
	T _C = 125 °C		125	VV		
Operating Junction and Storage Temperature Rar	T _J , T _{stg}	-55 to +175	°C			

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount c	R_{thJA}	40	°C/W		
Junction-to-Case (Drain)		R_{thJC}	0.4	G/ VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).



PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	•							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	2.5	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 60 V	1	-	1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 125 °C	-	-	50	μA	
		V _{GS} = 0 V	V _{DS} = 60 V, T _J = 175 °C	=	-	1.5	mA	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	120	-	=.	Α	
		V _{GS} = 10 V	I _D = 30 A	-	0.0016	-	Ω	
Drain-Source On-State Resistance a	В	V _{GS} = 10 V	I _D = 30 A, T _J = 125 °C	=	0.0031	-		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	0.0037	-		
		V _{GS} = 4.5 V	I _D = 20 A	-	0.0020	-		
Forward Transconductance b	9 _{fs}	V _{DS}	= 15 V, I _D = 30 A	=	164	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	12 060	15 100	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		=	5750	7200		
Reverse Transfer Capacitance	C _{rss}			1	860	1100		
Total Gate Charge ^c	Qg		V _{DS} = 30 V, I _D = 80 A	-	128	200		
Gate-Source Charge ^c	Q_{gs}	V _{GS} = 10 V		-	33	-	nC	
Gate-Drain Charge ^c	Q_{gd}			=	11	-		
Gate Resistance	Rg	f = 1 MHz		0.8	1.68	2.6	Ω	
Turn-On Delay Time ^c	t _{d(on)}				20	25		
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V, } R_L = 0.375 \ \Omega$ $I_D \cong 80 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1 \ \Omega$		=	15	40	ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	65	100		
Fall Time ^c	t _f			-	12	20		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	300	Α	
Forward Voltage	V _{SD}	I _F = 80 A, V _{GS} = 0 V		-	0.88	1.5	V	

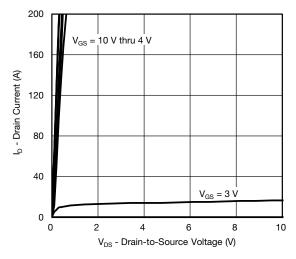
Notes

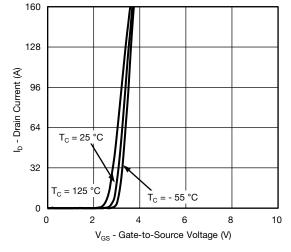
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

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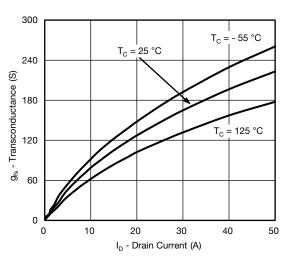
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

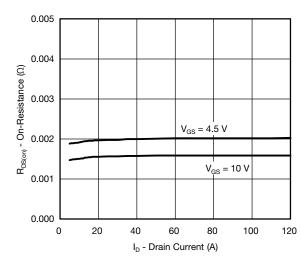




Output Characteristics

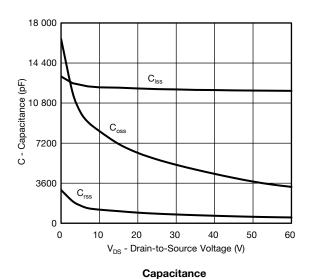


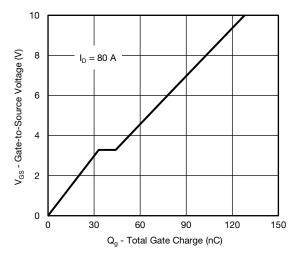




Transconductance

On-Resistance vs. Drain Current



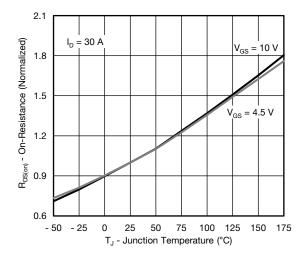


Gate Charge

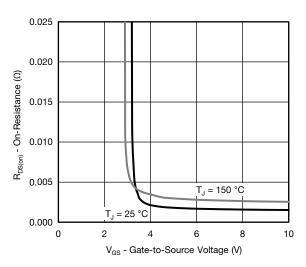
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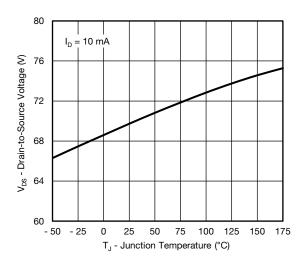
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



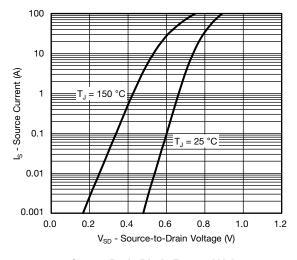
On-Resistance vs. Junction Temperature



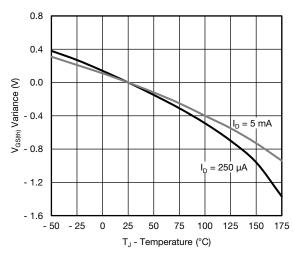
On-Resistance vs. Gate-to-Source Voltage



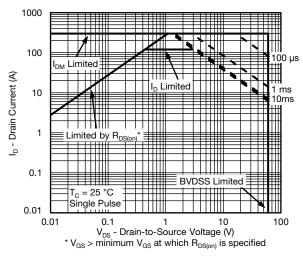
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



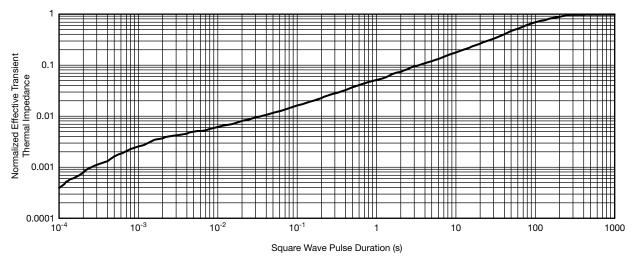
Threshold Voltage



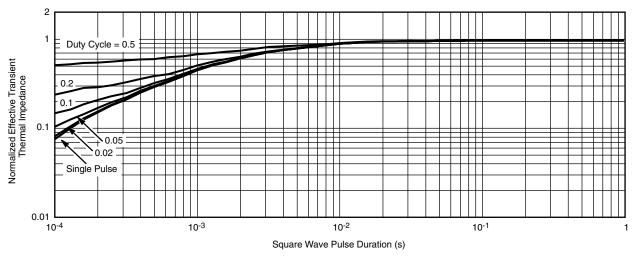
Safe Operating Area



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

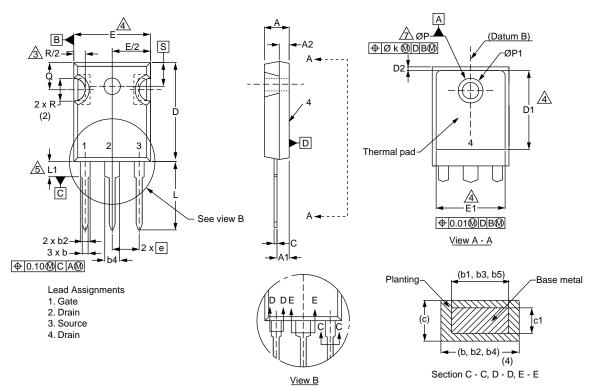
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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TO-247AC



	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-

	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
E	15.29	15.87	0.602	0.625
E1	13.72	-	0.540	-
е	5.46	BSC	0.215	BSC
Øk	0.254		0.010	
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
N	7.62 BSC		0.300 BSC	
ØΡ	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51	BSC	0.217	BSC

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